PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tadaharu KISHIBE	09/10/2008
Susumu NAKANO	09/10/2008
Takanori SHIBATA	09/10/2008

RECEIVING PARTY DATA

Name:	Hitachi, Ltd.
Street Address:	6-6, Marunouchi 1-chome, Chiyoda-ku
City:	Tokyo
State/Country:	JAPAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12202065

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: KAS-6630

NAME OF SUBMITTER: John R. Mattingly

Total Attachments: 1

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PATENT REEL: 024739 FRAME: 0744 12202

CH \$40.0

501243221

ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi, Ltd., a corporation organized under the laws of Japan,

located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi, Ltd.,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference preceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd.,

Signed on the date(s) indicated aside our signatures:

RECORDED: 07/26/2010

INVENTOR(S) (発明者フルネームサイン) T.K. 9/10/2008 Tadaharu Kishibu	Date Signed (署名日)
1) Tadaharw hishibra	9/10/2008.
Tadaharu KISHIBE 2) Susumu NAKANO Susumu NAKANO	9/10/2008
Susumu NAKANO V 3) Jakanori Shibata Takanori SHIBATA	9/10/2008
4)	
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9)	
10)	

PATENT REEL: 024739 FRAME: 0745